



Through Hole Lamp Product Data Sheet LTL307GC5D

Spec No.: DS20-2013-0171

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Revision: -

LITE-ON DCC

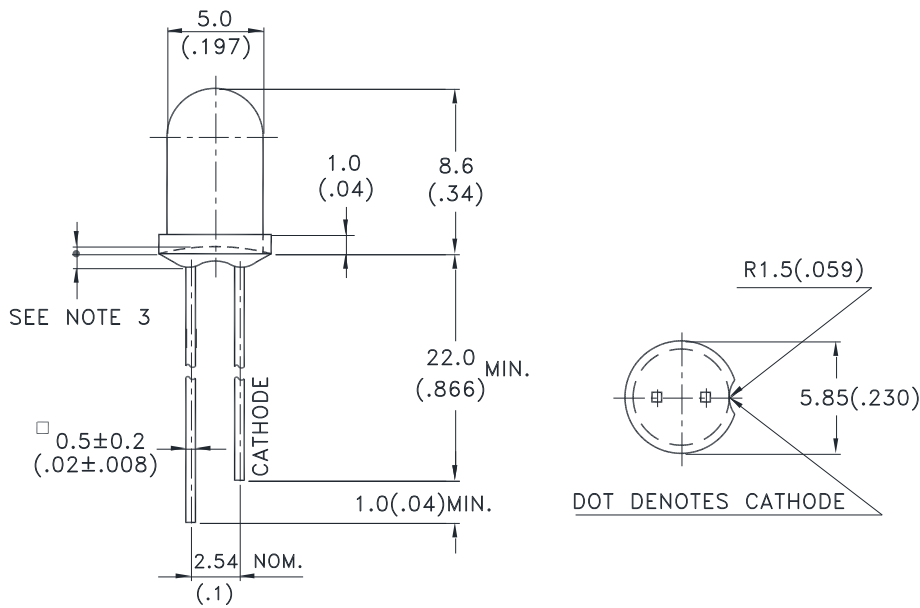
RELEASE

BNS-OD-FC001/A4

Features

- * Lead (Pb) free product – RoHS compliant.
- * Halogen free product (Cl < 900 ppm, Br < 900 ppm, and Cl + Br < 1500 ppm).
- * High luminous intensity output.
- * Low power consumption.
- * High efficiency.
- * Versatile mounting on P.C. Board or panel.
- * I.C. Compatible/low current requirement.
- * Popular T-13/4 diameter.

Package Dimensions



Part No.	Lens	Source Color
LTL307GC5D	Green Diffused	AllInGaP Green

Notes:

1. All dimensions are in millimeters (inches).
2. Tolerance is ±0.25mm(.010") unless otherwise noted.
3. Protruded resin under flange is 0.6 mm(.024") max.
4. Lead spacing is measured where the leads emerge from the package.
5. Specifications are subject to change without notice.



LITE-ON TECHNOLOGY CORPORATION

Property of Lite-On Only

Absolute Maximum Ratings at $T_A=25^\circ\text{C}$

Parameter	Maximum Rating	Unit
Power Dissipation	75	mW
Peak Forward Current (1/10 Duty Cycle, 0.1ms Pulse Width)	60	mA
DC Forward Current	20	mA
Operating Temperature Range	-40°C to + 85°C	
Storage Temperature Range	-40°C to + 100°C	
Lead Soldering Temperature [2.0 mm(.078") From Body]	265°C for 5 Seconds	

Electrical / Optical Characteristics at TA=25°C

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test Condition
Luminous Intensity	I _v	20	30	85	mcd	I _F = 10mA Note 1,4
Viewing Angle	2θ _{1/2}	-	50	-	deg	Note 2 (Fig.6)
Peak Emission Wavelength	λ _p	-	565	-	nm	Measurement @Peak (Fig.1)
Dominant Wavelength	λ _d	-	572	-	nm	I _F = 10mA Note 3
Spectral Line Half-Width	Δλ	-	11	-	nm	
Forward Voltage	V _F	1.7	-	2.6	V	I _F = 20mA
Reverse Current	I _R	-	-	100	μA	V _R = 5V Note 5

Note:1. Luminous intensity is measured with a light sensor and filter combination that approximates the CIE (Commission International De L'Eclairage) eye-response curve.

2. θ_{1/2} is the off-axis angle at which the luminous intensity is half the axial luminous intensity.
3. The dominant wavelength, λ_d is derived from the CIE chromaticity diagram and represents the single wavelength which defines the color of the device.
4. The I_v guarantee should be added ±15% .
5. Reverse voltage (V_R) condition is applied for I_R test only. The device is not designed for reverse operation.

Typical Electrical / Optical Characteristics Curves

(25°C Ambient Temperature Unless Otherwise Noted)

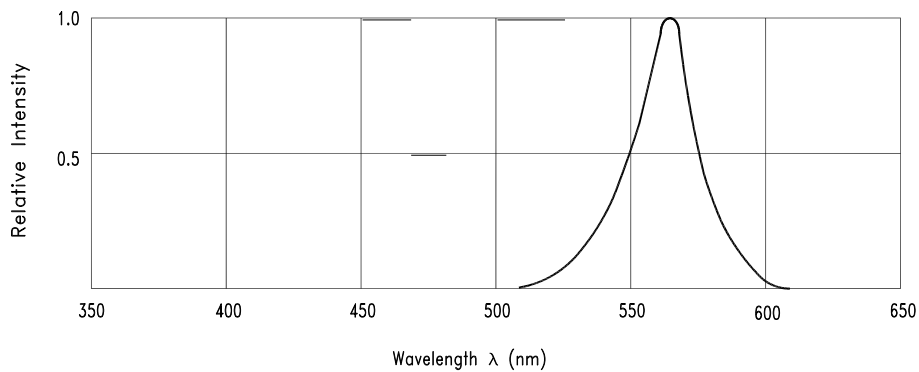


Fig.1 Relative Intensity vs. Wavelength

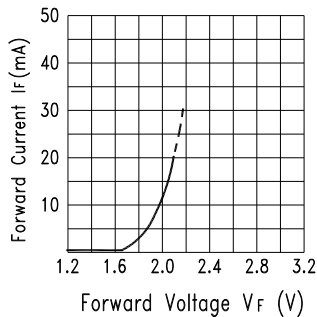


Fig.2 Forward Current vs. Forward Voltage

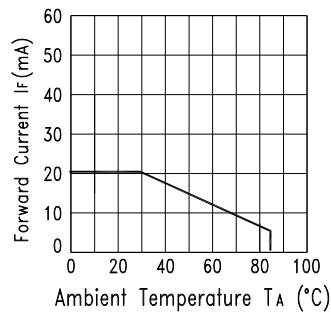


Fig.3 Forward Current Derating Curve

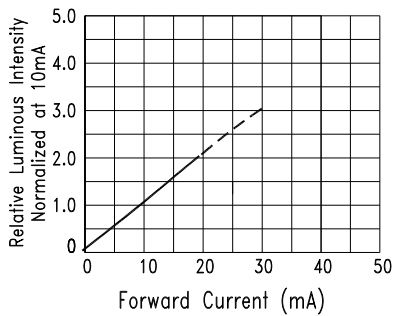


Fig.4 Relative Luminous Intensity vs. Forward Current

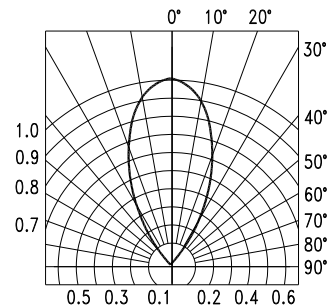
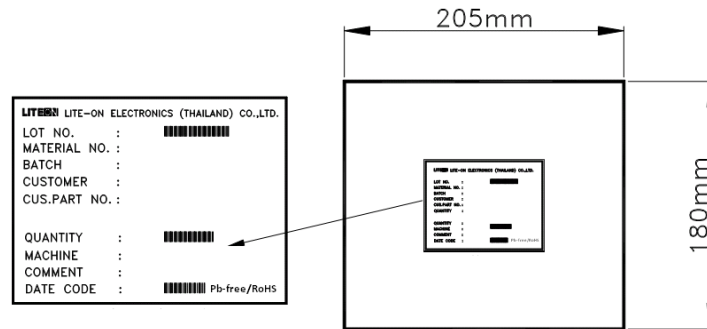
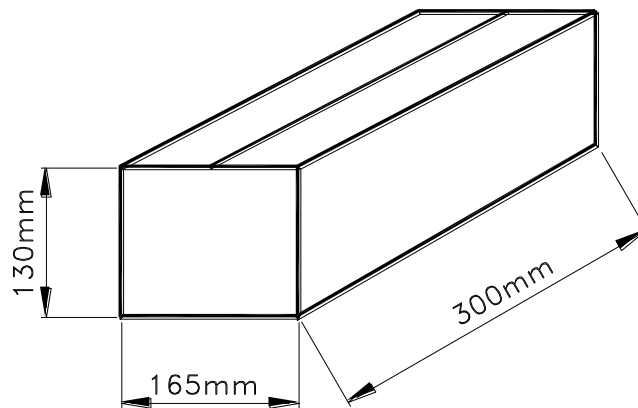
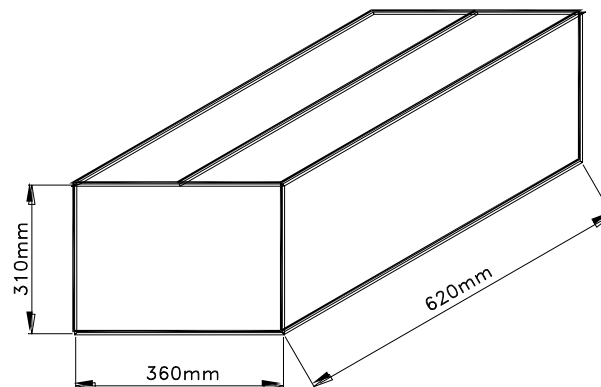


Fig.5 Spatial Distribution

Property of Lite-On Only

Packing Spec**1000, 500 or 250 pcs per packing bag****8 packing bags per inner carton
total 8000 pcs per inner carton****8 Inner cartons per outer carton
total 64000 pcs per outer carton****In every shipping lot, only the last pack will be non-full packing**

Bin Table Specifications

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Luminous Intensity		Unit : mcd @10mA
Bin Code	Min.	Max.
3Z	20	30
A	30	38
B	38	50
C	50	65
D	65	85

Note: Tolerance of each bin limit is $\pm 15\%$

CAUTIONS

1. Application

The LEDs described here are intended to be used for ordinary electronic equipment (such as office equipment, communication equipment and household applications). Consult Liteon's Sales in advance for information on applications in which exceptional reliability is required, particularly when the failure or malfunction of the LEDs may directly jeopardize life or health (such as in aviation, transportation, traffic control equipment, medical and life support systems and safety devices).

2. Storage

The storage ambient for the LEDs should not exceed 30°C temperature or 70% relative humidity. It is recommended that LEDs out of their original packaging are used within three months. For extended storage out of their original packaging, it is recommended that the LEDs be stored in a sealed container with appropriate desiccant or in desiccators with nitrogen ambient.

3. Cleaning

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LEDs if necessary.

4. Lead Forming & Assembly

During lead forming, the leads should be bent at a point at least 3mm from the base of LED lens. Do not use the base of the lead frame as a fulcrum during forming. Lead forming must be done before soldering, at normal temperature. During assembly on PCB, use minimum clinch force possible to avoid excessive mechanical stress.

5. Soldering

When soldering, leave a minimum of 2mm clearance from the base of the lens to the soldering point. Dipping the lens into the solder must be avoided. Do not apply any external stress to the lead frame during soldering while the LED is at high temperature.

Recommended soldering conditions :

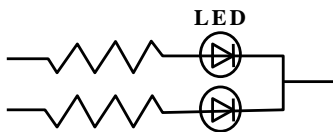
Soldering iron		Wave soldering	
Temperature	350°C Max.	Pre-heat	100°C Max.
Soldering time	3 sec. Max. (one time only)	Pre-heat time	60 sec. Max.
		Solder wave	265°C Max.
		Soldering time	5 sec. Max.

Note: Excessive soldering temperature and/or time might result in deformation of the LED lens or catastrophic failure of the LED

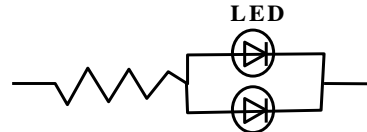
6. Drive Method

An LED is a current-operated device. In order to ensure intensity uniformity on multiple LEDs connected in parallel in an application, it is recommended that a current limiting resistor be incorporated in the drive circuit, in series with each LED as shown in Circuit A below.

Circuit model A



Circuit model B



(A) Recommended circuit

(B) The brightness of each LED might appear different due to the differences in the I-V characteristics of those LEDs

7. ESD (Electrostatic Discharge)

Static Electricity or power surge will damage the LED.

Suggestions to prevent ESD damage:

- Use a conductive wrist band or anti- electrostatic glove when handling these LEDs
- All devices, equipment, and machinery must be properly grounded
- Work tables, storage racks, etc. should be properly grounded
- Use ion blower to neutralize the static charge which might have built up on surface of the LEDs plastic lens as a result of friction between LEDs during storage and handling

Suggested checking list :

Training and Certification

1. Everyone working in a static-safe area is ESD-certified?
2. Training records kept and re-certification dates monitored?

Static-Safe Workstation & Work Areas

1. Static-safe workstation or work-areas have ESD signs?
2. All surfaces and objects at all static-safe workstation and within 1 ft measure less than 100V?
3. All ionizer activated, positioned towards the units?
4. Each work surface mats grounding is good?

Personnel Grounding

1. Every person (including visitors) handling ESD sensitive (ESDS) items wear wrist strap, heel strap or conductive shoes with conductive flooring?
2. If conductive footwear used, conductive flooring also present where operator stand or walk?
3. Garments, hairs or anything closer than 1 ft to ESD items measure less than 100V*?
4. Every wrist strap or heel strap/conductive shoes checked daily and result recorded for all DSL?
5. All wrist strap or heel strap checkers calibration up to date?

Note: *50V for Blue LED.

Device Handling

1. Every ESDS items identified by EIA-471 labels on item or packaging?
2. All ESDS items completely inside properly closed static-shielding containers when not at static-safe workstation?
3. No static charge generators (e.g. plastics) inside shielding containers with ESDS items?
4. All flexible conductive and dissipative package materials inspected before reuse or recycle?

Others

1. Audit result reported to entity ESD control coordinator?
2. Corrective action from previous audits completed?
3. Are audit records complete and on file?

8. Reliability Test				
	Classification	Test Item	Test Condition	Reference Standard
	Endurance Test	Operation Life	Ta= Under Room Temperature As Per Data Sheet Maximum Rating Test Time= 1000HRS	MIL-STD-750D:1026 MIL-STD-883G:1005
		High Temperature High Humidity Storage	Ta= 60°C RH= 90% Test Time= 240HRS	MIL-STD-202G:103B JEITA ED-4701:100 103
		High Temperature Storage	Ta= 105±5°C Test Time= 1000HRS	MIL-STD-750D:1031 MIL-STD-883G:1008 JEITA ED-4701:200 201
		Low Temperature Storage	Ta= -55±5°C Test Time=1000HRS	JEITA ED-4701:200 202
	Environmental Test	Temperature Cycling	100°C ~ 25°C ~ -40°C ~ 25°C 30mins 5mins 30mins 5mins 30 Cycles	MIL-STD-750D:1051 MIL-STD-883G:1010 JEITA ED-4701:100 105 JESD22-A104C
		Thermal Shock	105 ± 5°C ~ -30°C ± 5°C 15mins ~ 15mins 30 Cycles (< 20 secs transfer)	MIL-STD-750D:1056 MIL-STD-883G:1011 MIL-STD-202G: 107G JESD22-A106B
		Solder Resistance	T.sol = 260 ± 5°C Dwell Time = 5 ± 1 sec	MIL-STD-750D:2031 JEITA ED-4701:300 302
		Solderability	T. sol = 245 ± 5°C Dwell Time= 5 ± 0.5 sec (Lead Free Solder , Coverage≥ 95% of the dipped surface)	MIL-STD-750D:2026 MIL-STD-883G:2003 MIL-STD-202G: 208H IPC/EIA J-STD-002
		Soldering Iron	T. sol = 350 ± 5°C Dwell Time= 3.5 ± 0.5 sec	MIL-STD-202G: 208H JEITA ED-4701:300 302
9. Others				
The appearance and specifications of the product may be modified for improvement, without prior notice.				
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